

PATENT ASSIGNMENT

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CONVEYING PARTY DATA	
Name	Execution Date
Cheng-Hung Yu	04/14/2006
RECEIVING PARTY DATA	
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State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
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ASSIGNMENT OF INVENTION

I, (Assignor Name) **Cheng-Hung Yu**, residing at (Address)
No. 145, Dianchih St., Ciianchen Dist., Kao-Hsiung City, Taiwan, R.O.C.
, have invented a device called

" WAFER FOR MANUFACTURING IMAGE SENSORS, TEST KEY LAYOUT
FOR DEFECTS INSPECTION, AND METHODS FOR MANUFACTURING
IMAGE SENSORS AND FOR FORMING TEST KEY "

(Assignee name) **UNITED MICROELECTRONICS CORP.**
(hereinafter 'Assignee'), of (Assignee address)
No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City, Taiwan, R.O.C.

wishes to acquire the entire right, title, and interest in and to the invention and to any letters patent that may be granted therefor in the United States and in any and all foreign countries.

Accordingly, in consideration of the sum of One Dollar, (\$1.00) to me in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, Assignor, hereby sells, assigns, and transfers to Assignee the full and exclusive right to the above described invention in the United States and its territorial possessions, and in all foreign countries. The rights granted include the entire right, title, and interest in and to any and all letters patent which may be granted on the invention, including any rights gained by divisions, reissues, continuations, and extensions of the above described application.

I hereby authorize and request the Patent and Trademark Office Officials in the United States and any and all foreign countries to issue any and all letters patent, when issued, to Assignee, as the assignee of my entire right, title, and interest in and to the invention, for the sole use and enjoyment of Assignee and its successors and assignees.

Further, I agree that I will communicate to Assignee or its representatives any facts known to me respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid Assignee and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Date: APR. 14 2006
(請務必簽日期)

Cheng-Hung Yu (Assignor signature)
Cheng-Hung Yu (Print Assignor's name)